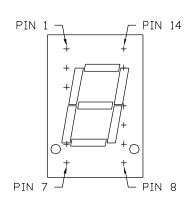
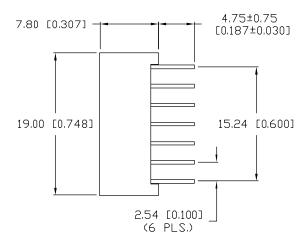
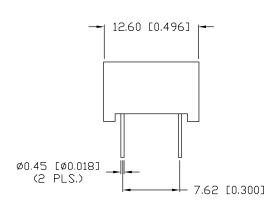
## UNCONTROLLED DOCUMENT

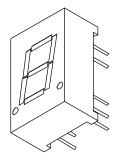
PART NUMBER

LDS-C413BI









10.00° -	
	F B 10.92 [0.430]
	E C C C D RDP

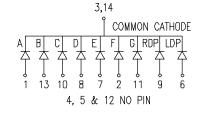
CHARACTER DETAIL

ELECTRO-OPTICAL CHARACTERISTICS TA=25°C  $I_f = 10 \text{mA}$ PARAMETER MIN TYP MAX UNITS TEST COND PEAK WAVELENGTH 585 nm FORWARD VOLTAGE 2.1 2.5 ٧f REVERSE VOLTAGE 5.0  $V_r$  $I_r=100\mu A$ AXIAL INTENSITY 3900 μcd If=10mA EMITTED COLOR: YELLOW FACE COLOR: GRAY SEGMENT COLOR: MILKY WHITE DIFFUSED

## LIMITS OF SAFE OPERATION AT 25°C PER CHIP

PARAMETER	MAX	UNITS
PEAK FORWARD CURRENT*	150	mA
STEADY CURRENT	30	mA
POWER DISSIPATION	105	mW
DERATE FROM 25°C	-1.2	mW/°C
OPERATING, STORAGE TEMP.	-40  TO  +85	•C
SOLDERING TEMP.	+ 260	<b>°</b> C
2.0mm FROM BODY		3 SEC. MAX
·		

\* t<10µS



\*UNLESS OTHERWISE SPECIFIED TOLERANCES PER DECIMAL PRECISION ARE: X=±1 (±0.039), X.X=±0.5 (±0.020), X.XX=±0.25 (±0.010), X.XXX=±0.127 (±0.005). LEAD SIZE=±0.05 (±0.002), LEAD LENGTH=±0.75 (±0.030). MIN= +DECIMAL PRECISION -0.000

PART NUMBER

CONFIDENTIAL INFORMATION

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RELIABILITY NOTE

OUR MANY YEARS OF EXPERIENCE DATA ACCUMULATION INDICATE THAT SOLDER HEAT IS A MAJOR CAUSE OF EARLY AND FUTURE FAILURE. PLEASE PAY ATTENTION TO YOUR SOLDERING PROCESS.



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DRAWN BY:

CHECKED BY:

APPROVED BY: DATE:

4.10.03 PAGE: 1 OF 1 SCALE: N/A

REV.

DS-C413BI

0.43" SINGLE DIGIT, SEVEN SEGMENT DISPLAY. 585nm YELLOW CHIPS, GRAY FACE WITH WHITE SEGMENTS, COMMON CATHODE.